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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

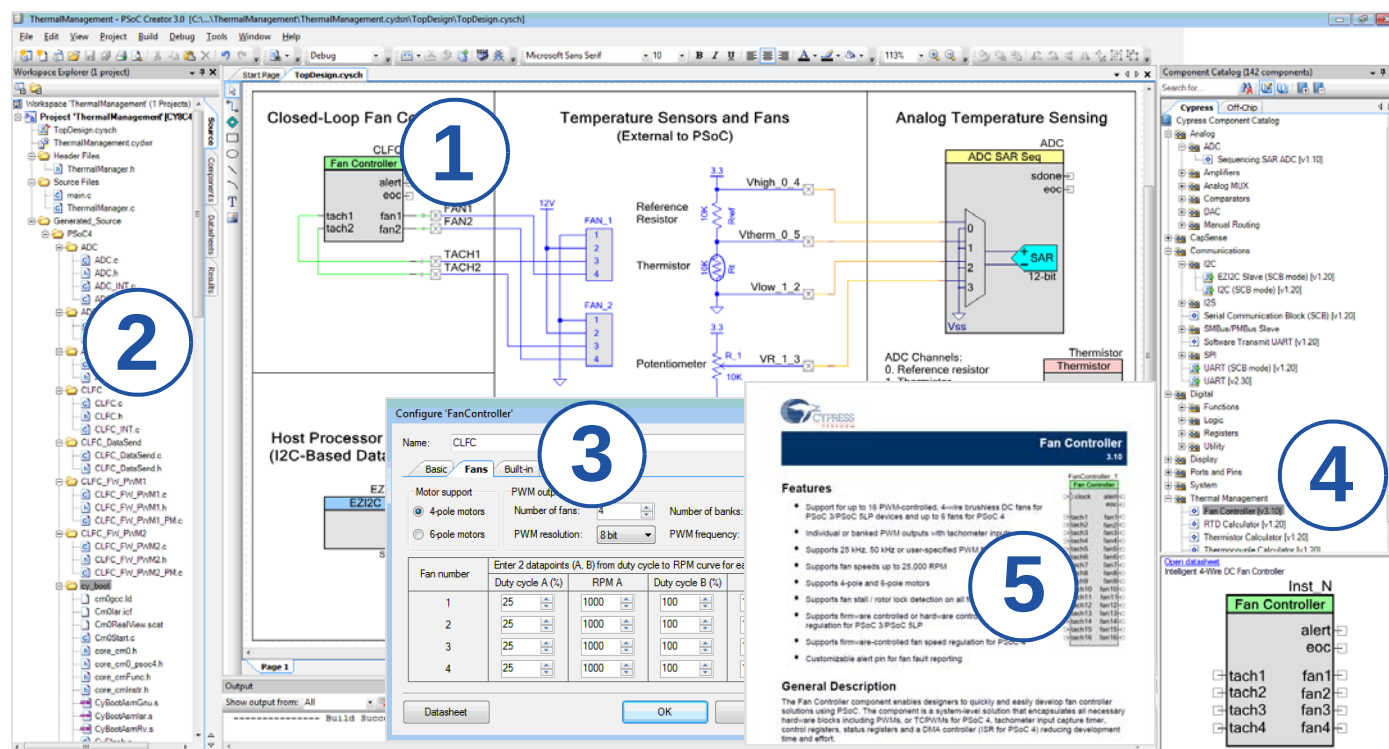
Product Status	Active
Core Processor	ARM® Cortex®-M0+
Core Size	32-Bit Single-Core
Speed	24MHz
Connectivity	I ² C, IrDA, LINbus, Microwire, SmartCard, SPI, SSP, UART/USART
Peripherals	Brown-out Detect/Reset, CapSense, LCD, POR, PWM, WDT
Number of I/O	54
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	1.71V ~ 5.5V
Data Converters	A/D 16x10b Slope, 16x12b SAR; D/A 2xIDAC
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/cy8c4126azi-s455

PSoC Creator

PSoC Creator is a free Windows-based Integrated Design Environment (IDE). It enables concurrent hardware and firmware design of PSoC 3, PSoC 4, and PSoC 5LP based systems. Create designs using classic, familiar schematic capture supported by over 100 pre-verified, production-ready PSoC Components; see the [list of component datasheets](#). With PSoC Creator, you can:

1. Drag and drop component icons to build your hardware system design in the main design workspace
2. Codesign your application firmware with the PSoC hardware, using the PSoC Creator IDE C compiler
3. Configure components using the configuration tools
4. Explore the library of 100+ components
5. Review component datasheets

Figure 1. Multiple-Sensor Example Project in PSoC Creator



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Programmable Digital Blocks

Smart I/O Block

The Smart I/O block is a fabric of switches and LUTs that allows Boolean functions to be performed in signals being routed to the pins of a GPIO port. The Smart I/O can perform logical operations on input pins to the chip and on signals going out as outputs.

Fixed Function Digital Blocks

Timer/Counter/PWM (TCPWM) Block

The TCPWM block consists of a 16-bit counter with user-programmable period length. There is a capture register to record the count value at the time of an event (which may be an I/O event), a period register that is used to either stop or auto-reload the counter when its count is equal to the period register, and compare registers to generate compare value signals that are used as PWM duty cycle outputs. The block also provides true and complementary outputs with programmable offset between them to allow use as dead-band programmable complementary PWM outputs. It also has a Kill input to force outputs to a predetermined state; for example, this is used in motor drive systems when an over-current state is indicated and the PWM driving the FETs needs to be shut off immediately with no time for software intervention. Each block also incorporates a Quadrature decoder. There are eight TCPWM blocks in PSoC 4100S Plus.

Serial Communication Block (SCB)

PSoC 4100S Plus has five serial communication blocks, which can be programmed to have SPI, I²C, or UART functionality.

I²C Mode: The hardware I²C block implements a full multi-master and slave interface (it is capable of multi-master arbitration). This block is capable of operating at speeds of up to 400 kbps (Fast Mode) and has flexible buffering options to reduce interrupt overhead and latency for the CPU. It also supports EZI2C that creates a mailbox address range in the memory of PSoC 4100S Plus and effectively reduces I²C communication to reading from and writing to an array in memory. In addition, the block supports an 8-deep FIFO for receive and transmit which, by increasing the time given for the CPU to read data, greatly reduces the need for clock stretching caused by the CPU not having read data on time.

The I²C peripheral is compatible with the I²C Standard-mode and Fast-mode devices as defined in the NXP I²C-bus specification and user manual (UM10204). The I²C bus I/O is implemented with GPIO in open-drain modes.

PSoC 4100S Plus is not completely compliant with the I²C spec in the following respect:

- GPIO cells are not overvoltage tolerant and, therefore, cannot be hot-swapped or powered up independently of the rest of the I²C system.

UART Mode: This is a full-feature UART operating at up to 1 Mbps. It supports automotive single-wire interface (LIN), infrared interface (IrDA), and SmartCard (ISO7816) protocols, all of which are minor variants of the basic UART protocol. In addition, it supports the 9-bit multiprocessor mode that allows addressing of peripherals connected over common RX and TX lines. Common UART functions such as parity error, break detect, and frame error are supported. An 8-deep FIFO allows much greater CPU service latencies to be tolerated.

SPI Mode: The SPI mode supports full Motorola SPI, TI SSP (adds a start pulse used to synchronize SPI Codecs), and National Microwire (half-duplex form of SPI). The SPI block can use the FIFO.

CAN

There is a CAN 2.0B block with support for TT-CAN.

GPIO

PSoC 4100S Plus has up to 54 GPIOs. The GPIO block implements the following:

- Eight drive modes:
 - Analog input mode (input and output buffers disabled)
 - Input only
 - Weak pull-up with strong pull-down
 - Strong pull-up with weak pull-down
 - Open drain with strong pull-up
 - Open drain with strong pull-up
 - Strong pull-up with strong pull-down
 - Weak pull-up with weak pull-down
- Input threshold select (CMOS or LVTTL).
- Individual control of input and output buffer enabling/disabling in addition to the drive strength modes
- Selectable slew rates for dV/dt related noise control to improve EMI

The pins are organized in logical entities called ports, which are 8-bit in width (less for Ports 5 and 6). During power-on and reset, the blocks are forced to the disable state so as not to crowbar any inputs and/or cause excess turn-on current. A multiplexing network known as a high-speed I/O matrix is used to multiplex between various signals that may connect to an I/O pin.

Data output and pin state registers store, respectively, the values to be driven on the pins and the states of the pins themselves.

Every I/O pin can generate an interrupt if so enabled and each I/O port has an interrupt request (IRQ) and interrupt service routine (ISR) vector associated with it.

Pinouts

The following table provides the pin list for PSoC 4100S Plus for the 44-pin TQFP and 64-pin TQFP Normal and Fine Pitch packages.

64-TQFP		44-TQFP	
Pin	Name	Pin	Name
39	P0.0	24	P0.0
40	P0.1	25	P0.1
41	P0.2	26	P0.2
42	P0.3	27	P0.3
43	P0.4	28	P0.4
44	P0.5	29	P0.5
45	P0.6	30	P0.6
46	P0.7	31	P0.7
47	XRES	32	XRES
48	VCCD	33	VCCD
49	VSSD		
50	VDDD	34	VDDD
51	P5.0		
52	P5.1		
53	P5.2		
54	P5.3		
55	P5.5		
56	VDDA	35	VDDA
57	VSSA	36	VSSA
58	P1.0	37	P1.0
59	P1.1	38	P1.1
60	P1.2	39	P1.2
61	P1.3	40	P1.3
62	P1.4	41	P1.4
63	P1.5	42	P1.5
64	P1.6	43	P1.6
1	P1.7	44	P1.7
		1	VSSD
2	P2.0	2	P2.0
3	P2.1	3	P2.1
4	P2.2	4	P2.2
5	P2.3	5	P2.3
6	P2.4	6	P2.4
7	P2.5	7	P2.5
8	P2.6	8	P2.6
9	P2.7	9	P2.7
10	VSSD	10	P6.0
11	No Connect (NC)		
12	P6.0		
13	P6.1		

Alternate Pin Functions

Each Port pin has can be assigned to one of multiple functions; it can, for example, be an analog I/O, a digital peripheral function, an LCD pin, or a CapSense pin. The pin assignments are shown in the following table.

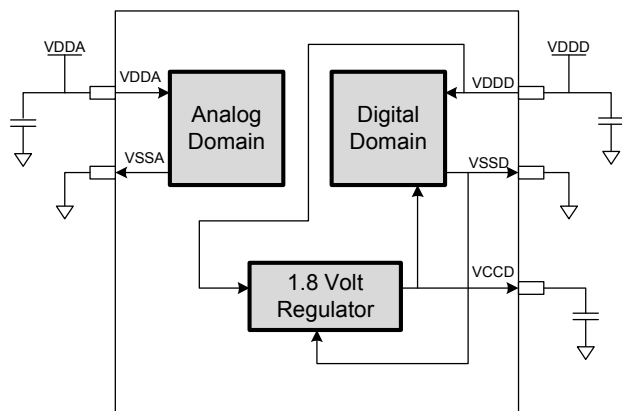
Port/Pin	Analog	Smart I/O	ACT #0	ACT #1	ACT #3	DS #2	DS #3
P0.0	lpcomp.in_p[0]			tcpwm.tr_in[0]	scb[2].uart_cts:0	scb[2].i2c_scl:0	scb[0].spi_select1:0
P0.1	lpcomp.in_n[0]			tcpwm.tr_in[1]	scb[2].uart_rts:0	scb[2].i2c_sda:0	scb[0].spi_select2:0
P0.2	lpcomp.in_p[1]						scb[0].spi_select3:0
P0.3	lpcomp.in_n[1]						scb[2].spi_select0:1
P0.4	wco.wco_in			scb[1].uart_rx:0	scb[2].uart_rx:0	scb[1].i2c_scl:0	scb[1].spi_mosi:1
P0.5	wco.wco_out			scb[1].uart_tx:0	scb[2].uart_tx:0	scb[1].i2c_sda:0	scb[1].spi_miso:1
P0.6	exco.eco_in		srss.ext_clk:0	scb[1].uart_cts:0	scb[2].uart_tx:1		scb[1].spi_clk:1
P0.7	exco.eco_out		tcpwm.line[0]:3	scb[1].uart_rts:0			scb[1].spi_select0:1
P5.0			tcpwm.line[4]:2		scb[2].uart_rx:1	scb[2].i2c_scl:1	scb[2].spi_mosi:0
P5.1			tcpwm.line_compl[4]:2		scb[2].uart_tx:2	scb[2].i2c_sda:1	scb[2].spi_miso:0
P5.2			tcpwm.line[5]:2		scb[2].uart_cts:1	lpcomp.comp[0]:2	scb[2].spi_clk:0
P5.3			tcpwm.line_compl[5]:2		scb[2].uart_rts:1	lpcomp.comp[1]:0	scb[2].spi_select0:0
P5.4			tcpwm.line[6]:2				scb[2].spi_select1:0
P5.5			tcpwm.line_compl[6]:2				scb[2].spi_select2:0
P1.0	ctb0_oa0+	Smartlo[2].io[0]	tcpwm.line[2]:1	scb[0].uart_rx:1		scb[0].i2c_scl:0	scb[0].spi_mosi:1
P1.1	ctb0_oa0-	Smartlo[2].io[1]	tcpwm.line_compl[2]:1	scb[0].uart_tx:1		scb[0].i2c_sda:0	scb[0].spi_miso:1
P1.2	ctb0_oa0_out	Smartlo[2].io[2]	tcpwm.line[3]:1	scb[0].uart_cts:1	tcpwm.tr_in[2]	scb[2].i2c_scl:2	scb[0].spi_clk:1
P1.3	ctb0_oa1_out	Smartlo[2].io[3]	tcpwm.line_compl[3]:1	scb[0].uart_rts:1	tcpwm.tr_in[3]	scb[2].i2c_sda:2	scb[0].spi_select0:1
P1.4	ctb0_oa1-	Smartlo[2].io[4]	tcpwm.line[6]:1			scb[3].i2c_scl:0	scb[0].spi_select1:1
P1.5	ctb0_oa1+	Smartlo[2].io[5]	tcpwm.line_compl[6]:1			scb[3].i2c_sda:0	scb[0].spi_select2:1
P1.6	ctb0_oa0+	Smartlo[2].io[6]	tcpwm.line[7]:1				scb[0].spi_select3:1
P1.7	ctb0_oa1+ sar_ext_vref0 sar_ext_vref1	Smartlo[2].io[7]	tcpwm.line_compl[7]:1				scb[2].spi_clk:1
P2.0	sarmux[0]	Smartlo[0].io[0]	tcpwm.line[4]:0	csd.comp	tcpwm.tr_in[4]	scb[1].i2c_scl:1	scb[1].spi_mosi:2
P2.1	sarmux[1]	Smartlo[0].io[1]	tcpwm.line_compl[4]:0		tcpwm.tr_in[5]	scb[1].i2c_sda:1	scb[1].spi_miso:2
P2.2	sarmux[2]	Smartlo[0].io[2]	tcpwm.line[5]:1				scb[1].spi_clk:2
P2.3	sarmux[3]	Smartlo[0].io[3]	tcpwm.line_compl[5]:1				scb[1].spi_select0:2

Port/Pin	Analog	Smart I/O	ACT #0	ACT #1	ACT #3	DS #2	DS #3
P2.4	sarmux[4]	Smartlo[0].io[4]	tcpwm.line[0]:1	scb[3].uart_rx:1			scb[1].spi_select1:1
P2.5	sarmux[5]	Smartlo[0].io[5]	tcpwm.line_compl[0]:1	scb[3].uart_tx:1			scb[1].spi_select2:1
P2.6	sarmux[6]	Smartlo[0].io[6]	tcpwm.line[1]:1	scb[3].uart_cts:1			scb[1].spi_select3:1
P2.7	sarmux[7]	Smartlo[0].io[7]	tcpwm.line_compl[1]:1	scb[3].uart_rts:1		lpcomp.comp[0]:0	scb[2].spi_mosi:1
P6.0			tcpwm.line[4]:1	scb[3].uart_rx:0	can.can_tx_enb_n:0	scb[3].i2c_scl:1	scb[3].spi_mosi:0
P6.1			tcpwm.line_compl[4]:1	scb[3].uart_tx:0	can.can_rx:0	scb[3].i2c_sda:1	scb[3].spi_miso:0
P6.2			tcpwm.line[5]:0	scb[3].uart_cts:0	can.can_tx:0		scb[3].spi_clk:0
P6.3			tcpwm.line_compl[5]:0	scb[3].uart_rts:0			scb[3].spi_select0:0
P6.4			tcpwm.line[6]:0			scb[4].i2c_scl	scb[3].spi_select1:0
P6.5			tcpwm.line_compl[6]:0			scb[4].i2c_sda	scb[3].spi_select2:0
P3.0		Smartlo[1].io[0]	tcpwm.line[0]:0	scb[1].uart_rx:1		scb[1].i2c_scl:2	scb[1].spi_mosi:0
P3.1		Smartlo[1].io[1]	tcpwm.line_compl[0]:0	scb[1].uart_tx:1		scb[1].i2c_sda:2	scb[1].spi_miso:0
P3.2		Smartlo[1].io[2]	tcpwm.line[1]:0	scb[1].uart_cts:1		cpuss.swd_data	scb[1].spi_clk:0
P3.3		Smartlo[1].io[3]	tcpwm.line_compl[1]:0	scb[1].uart_rts:1		cpuss.swd_clk	scb[1].spi_select0:0
P3.4		Smartlo[1].io[4]	tcpwm.line[2]:0		tcpwm.tr_in[6]		scb[1].spi_select1:0
P3.5		Smartlo[1].io[5]	tcpwm.line_compl[2]:0				scb[1].spi_select2:0
P3.6		Smartlo[1].io[6]	tcpwm.line[3]:0			scb[4].spi_select3	scb[1].spi_select3:0
P3.7		Smartlo[1].io[7]	tcpwm.line_compl[3]:0			lpcomp.comp[1]:1	scb[2].spi_miso:1
P4.0	csd.vref_ext			scb[0].uart_rx:0	can.can_rx:1	scb[0].i2c_scl:1	scb[0].spi_mosi:0
P4.1	csd.cshield			scb[0].uart_tx:0	can.can_tx:1	scb[0].i2c_sda:1	scb[0].spi_miso:0
P4.2	csd.cmod			scb[0].uart_cts:0	can.can_tx_enb_n:1	lpcomp.comp[0]:1	scb[0].spi_clk:0
P4.3	csd.csh_tank			scb[0].uart_rts:0		lpcomp.comp[1]:2	scb[0].spi_select0:0
P4.4				scb[4].uart_rx		scb[4].spi_mosi	scb[0].spi_select1:2
P4.5				scb[4].uart_tx		scb[4].spi_miso	scb[0].spi_select2:2
P4.6				scb[4].uart_cts		scb[4].spi_clk	scb[0].spi_select3:2
P4.7				scb[4].uart_rts		scb[4].spi_select0	
P5.6			tcpwm.line[7]:0			scb[4].spi_select1	scb[2].spi_select3:0
P5.7			tcpwm.line_compl[7]:0			scb[4].spi_select2	
P7.0			tcpwm.line[0]:2	scb[3].uart_rx:2		scb[3].i2c_scl:2	scb[3].spi_mosi:1
P7.1			tcpwm.line_compl[0]:2	scb[3].uart_tx:2		scb[3].i2c_sda:2	scb[3].spi_miso:1
P7.2			tcpwm.line[1]:2	scb[3].uart_cts:2			scb[3].spi_clk:1

Power

The following power system diagram shows the set of power supply pins as implemented for the PSoC 4100S Plus. The system has one regulator in Active mode for the digital circuitry. There is no analog regulator; the analog circuits run directly from the V_{DD} input.

Figure 5. Power Supply Connections



There are two distinct modes of operation. In Mode 1, the supply voltage range is 1.8 V to 5.5 V (unregulated externally; internal regulator operational). In Mode 2, the supply range is 1.8 V $\pm$ 5% (externally regulated; 1.71 to 1.89, internal regulator bypassed).

Mode 1: 1.8 V to 5.5 V External Supply

In this mode, PSoC 4100S Plus is powered by an external power supply that can be anywhere in the range of 1.8 to 5.5 V. This range is also designed for battery-powered operation. For example, the chip can be powered from a battery system that starts at 3.5 V and works down to 1.8 V. In this mode, the internal regulator of PSoC 4100S Plus supplies the internal logic and its output is connected to the V_{CCD} pin. The V_{CCD} pin must be bypassed to ground via an external capacitor (0.1 μ F; X5R ceramic or better) and must not be connected to anything else.

Mode 2: 1.8 V $\pm$ 5% External Supply

In this mode, PSoC 4100S Plus is powered by an external power supply that must be within the range of 1.71 to 1.89 V; note that this range needs to include the power supply ripple too. In this mode, the V_{DD} and V_{CCD} pins are shorted together and bypassed. The internal regulator can be disabled in the firmware.

Bypass capacitors must be used from V_{DDD} to ground. The typical practice for systems in this frequency range is to use a capacitor in the 1- μ F range, in parallel with a smaller capacitor (0.1 μ F, for example). Note that these are simply rules of thumb and that, for critical applications, the PCB layout, lead inductance, and the bypass capacitor parasitic should be simulated to design and obtain optimal bypassing.

An example of a bypass scheme is shown in the following diagram.

Figure 6. External Supply Range from 1.8 V to 5.5 V with Internal Regulator Active

Power supply bypass connections example

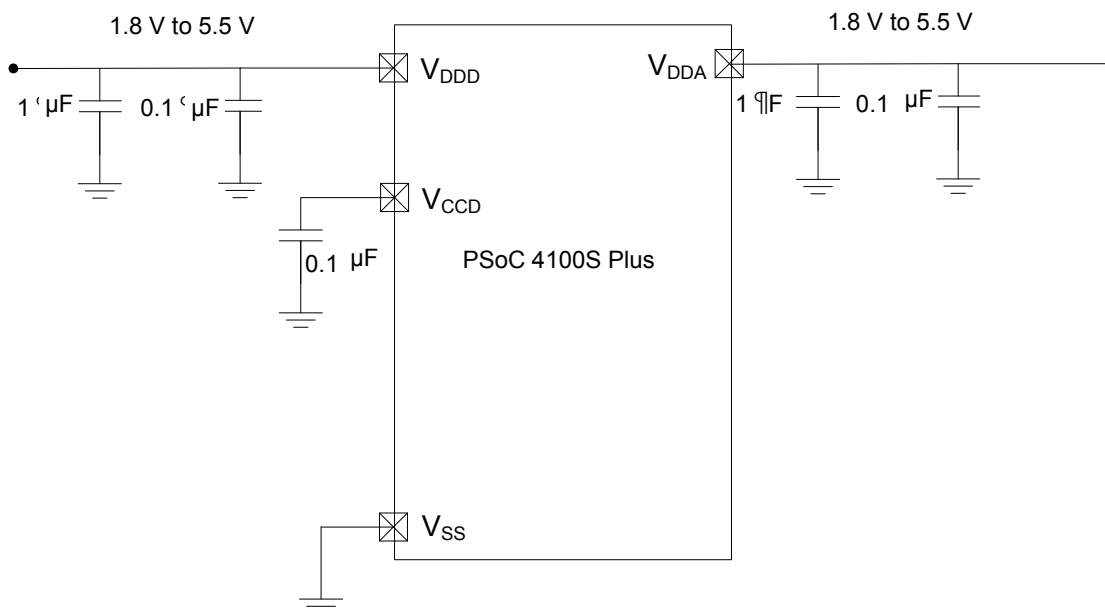


Table 2. DC Specifications (continued)

 Typical values measured at $V_{DD} = 3.3\text{ V}$ and $25\text{ }^{\circ}\text{C}$.

Spec ID#	Parameter	Description	Min	Typ	Max	Units	Details/ Conditions
Sleep Mode, V _{DDD} = 1.8 V to 5.5 V (Regulator on)							
SID22	I _{DD17}	I ² C wakeup WDT, and Comparators on	–	1.1	1.8	mA	6 MHZ. Max is at 85 °C and 5.5 V
SID25	I _{DD20}	I ² C wakeup, WDT, and Comparators on	–	1.5	2.1		12 MHZ. Max is at 85 °C and 5.5 V
Sleep Mode, V _{DDD} = 1.71 V to 1.89 V (Regulator bypassed)							
SID28	I _{DD23}	I ² C wakeup, WDT, and Comparators on	–	1.1	1.8	mA	6 MHZ. Max is at 85 °C and 1.89 V
SID28A	I _{DD23A}	I ² C wakeup, WDT, and Comparators on	–	1.5	2.1	mA	12 MHZ. Max is at 85 °C and 1.89 V
Deep Sleep Mode, V _{DD} = 1.8 V to 3.6 V (Regulator on)							
SID30	I _{DD25}	I ² C wakeup and WDT on; T = –40 °C to 60 °C	–	2.5	40	μA	T = –40 °C to 60 °C
SID31	I _{DD26}	I ² C wakeup and WDT on	–	2.5	125	μA	Max is at 3.6 V and 85 °C
Deep Sleep Mode, V _{DD} = 3.6 V to 5.5 V (Regulator on)							
SID33	I _{DD28}	I ² C wakeup and WDT on; T = –40 °C to 60 °C	–	2.5	40	μA	T = –40 °C to 60 °C
SID34	I _{DD29}	I ² C wakeup and WDT on	–	2.5	125	μA	Max is at 5.5 V and 85 °C
Deep Sleep Mode, V _{DD} = V _{CCD} = 1.71 V to 1.89 V (Regulator bypassed)							
SID36	I _{DD31}	I ² C wakeup and WDT on; T = –40 °C to 60 °C	–	2.5	60	μA	T = –40 °C to 60 °C
SID37	I _{DD32}	I ² C wakeup and WDT on	–	2.5	180	μA	Max is at 1.89 V and 85 °C
XRES Current							
SID307	I _{DD XR}	Supply current while XRES asserted	–	2	5	mA	–

Table 3. AC Specifications

Spec ID#	Parameter	Description	Min	Typ	Max	Units	Details/ Conditions
SID48	F_{CPU}	CPU frequency	DC	–	48	MHz	$1.71 \leq V_{DD} \leq 5.5$
SID49 ^[2]	T_{SLEEP}	Wakeup from Sleep mode	–	0	–	μs	
SID50 ^[2]	$T_{DEEPSLEEP}$	Wakeup from Deep Sleep mode	–	35	–		

Note

2. Guaranteed by characterization.

Table 5. GPIO AC Specifications (continued)
 (Guaranteed by Characterization)

Spec ID#	Parameter	Description	Min	Typ	Max	Units	Details/ Conditions
SID73	T_{FALLS}	Fall time in slow strong mode	10	–	60	–	3.3 V V_{DD} , $C_{load} = 25$ pF
SID74	$F_{GPIOOUT1}$	GPIO F_{OUT} ; $3.3\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ Fast strong mode	–	–	33	MHz	90/10%, 25 pF load, 60/40 duty cycle
SID75	$F_{GPIOOUT2}$	GPIO F_{OUT} ; $1.71\text{ V} \leq V_{DD} \leq 3.3\text{ V}$ Fast strong mode	–	–	16.7		90/10%, 25 pF load, 60/40 duty cycle
SID76	$F_{GPIOOUT3}$	GPIO F_{OUT} ; $3.3\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ Slow strong mode	–	–	7		90/10%, 25 pF load, 60/40 duty cycle
SID245	$F_{GPIOOUT4}$	GPIO F_{OUT} ; $1.71\text{ V} \leq V_{DD} \leq 3.3\text{ V}$ Slow strong mode.	–	–	3.5		90/10%, 25 pF load, 60/40 duty cycle
SID246	F_{GPIOIN}	GPIO input operating frequency; $1.71\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	–	–	48		90/10% V_{IO}

XRES
Table 6. XRES DC Specifications

Spec ID#	Parameter	Description	Min	Typ	Max	Units	Details/ Conditions
SID77	V_{IH}	Input voltage high threshold	$0.7 \times V_{DD}$	–	–	V	CMOS Input
SID78	V_{IL}	Input voltage low threshold	–	–	$0.3 \times V_{DD}$		
SID79	R_{PULLUP}	Pull-up resistor	–	60	–	k Ω	–
SID80	C_{IN}	Input capacitance	–	–	7	pF	–
SID81 ^[5]	$V_{HYSXRES}$	Input voltage hysteresis	–	100	–	mV	Typical hysteresis is 200 mV for $V_{DD} > 4.5\text{ V}$
SID82	I_{DIODE}	Current through protection diode to V_{DD}/V_{SS}	–	–	100	μ A	

Table 7. XRES AC Specifications

Spec ID#	Parameter	Description	Min	Typ	Max	Units	Details/ Conditions
SID83 ^[5]	$T_{RESETWIDTH}$	Reset pulse width	1	–	–	μ s	–
BID194 ^[5]	$T_{RESETWAKE}$	Wake-up time from reset release	–	–	2.7	ms	–

Note

5. Guaranteed by characterization.

Table 8. CTBm Opamp Specifications *(continued)*

Spec ID#	Parameter	Description	Min	Typ	Max	Units	Details/ Conditions
SID283	V _{OUT_1}	power=hi, Iload=10 mA	0.5	–	V _{DDA} -0.5	V	–
SID284	V _{OUT_2}	power=hi, Iload=1 mA	0.2	–	V _{DDA} -0.2		–
SID285	V _{OUT_3}	power=med, Iload=1 mA	0.2	–	V _{DDA} -0.2		–
SID286	V _{OUT_4}	power=lo, Iload=0.1 mA	0.2	–	V _{DDA} -0.2		–
SID288	V _{OS_TR}	Offset voltage, trimmed	–1.0	±0.5	1.0	mV	High mode, input 0 V to V _{DDA} -0.2 V
SID288A	V _{OS_TR}	Offset voltage, trimmed	–	±1	–		Medium mode, input 0 V to V _{DDA} -0.2 V
SID288B	V _{OS_TR}	Offset voltage, trimmed	–	±2	–		Low mode, input 0 V to V _{DDA} -0.2 V
SID290	V _{OS_DR_TR}	Offset voltage drift, trimmed	–10	±3	10	µV/°C	High mode
SID290A	V _{OS_DR_TR}	Offset voltage drift, trimmed	–	±10	–	µV/°C	Medium mode
SID290B	V _{OS_DR_TR}	Offset voltage drift, trimmed	–	±10	–		Low mode
SID291	CMRR	DC	70	80	–	dB	Input is 0 V to V _{DDA} -0.2 V, Output is 0.2 V to V _{DDA} -0.2 V
SID292	PSRR	At 1 kHz, 10-mV ripple	70	85	–		V _{DDD} = 3.6 V, high-power mode, input is 0.2 V to V _{DDA} -0.2 V
	Noise						
SID294	VN2	Input-referred, 1 kHz, power = Hi	–	72	–	nV/rHz	Input and output are at 0.2 V to V _{DDA} -0.2 V
SID295	VN3	Input-referred, 10 kHz, power = Hi	–	28	–		Input and output are at 0.2 V to V _{DDA} -0.2 V
SID296	VN4	Input-referred, 100 kHz, power = Hi	–	15	–		Input and output are at 0.2 V to V _{DDA} -0.2 V
SID297	C _{LOAD}	Stable up to max. load. Performance specs at 50 pF.	–	–	125	pF	–
SID298	SLEW_RATE	Cload = 50 pF, Power = High, V _{DDA} = 2.7 V	6	–	–	V/µs	–
SID299	T _{OP_WAKE}	From disable to enable, no external RC dominating	–	–	25	µs	–
SID299A	OL_GAIN	Open Loop Gain	–	90	–	dB	
	COMP_MODE	Comparator mode; 50 mV drive, T _{rise} =T _{fall} (approx.)					

Table 8. CTBm Opamp Specifications (continued)

Spec ID#	Parameter	Description	Min	Typ	Max	Units	Details/ Conditions
SID_DS_19	I _{OUT_HI_M1}	Mode 1, High current	–	10	–	mA	Output is 0.5 V to V _{DDA} -0.5 V
SID_DS_20	I _{OUT_MED_M1}	Mode 1, Medium current	–	10	–		Output is 0.5 V to V _{DDA} -0.5 V
SID_DS_21	I _{OUT_LOW_M1}	Mode 1, Low current	–	4	–		Output is 0.5 V to V _{DDA} -0.5 V
SID_DS_22	I _{OUT_HI_M2}	Mode 2, High current	–	1	–		
SID_DS_23	I _{OUT_MED_M2}	Mode 2, Medium current	–	1	–		
SID_DS_24	I _{OUT_LOW_M2}	Mode 2, Low current	–	0.5	–		

Comparator

Table 9. Comparator DC Specifications

Spec ID#	Parameter	Description	Min	Typ	Max	Units	Details/ Conditions
SID84	V _{OFFSET1}	Input offset voltage, Factory trim	–	–	±10	mV	
SID85	V _{OFFSET2}	Input offset voltage, Custom trim	–	–	±4		
SID86	V _{HYST}	Hysteresis when enabled	–	10	35		
SID87	V _{ICM1}	Input common mode voltage in normal mode	0	–	V _{DDD} -0.1	V	Modes 1 and 2
SID247	V _{ICM2}	Input common mode voltage in low power mode	0	–	V _{DDD}		
SID247A	V _{ICM3}	Input common mode voltage in ultra low power mode	0	–	V _{DDD} -1.15		V _{DDD} ≥ 2.2 V at –40 °C
SID88	C _{MRR}	Common mode rejection ratio	50	–	–	dB	V _{DDD} ≥ 2.7V
SID88A	C _{MRR}	Common mode rejection ratio	42	–	–		V _{DDD} ≤ 2.7V
SID89	I _{CMP1}	Block current, normal mode	–	–	400	μA	
SID248	I _{CMP2}	Block current, low power mode	–	–	100		
SID259	I _{CMP3}	Block current in ultra low-power mode	–	–	6		V _{DDD} ≥ 2.2 V at –40 °C
SID90	Z _{CMP}	DC Input impedance of comparator	35	–	–	MΩ	

Table 10. Comparator AC Specifications

Spec ID#	Parameter	Description	Min	Typ	Max	Units	Details/ Conditions
SID91	TRESP1	Response time, normal mode, 50 mV overdrive	–	38	110	ns	
SID258	TRESP2	Response time, low power mode, 50 mV overdrive	–	70	200		
SID92	TRESP3	Response time, ultra-low power mode, 200 mV overdrive	–	2.3	15	μs	V _{DDD} ≥ 2.2 V at –40 °C

Note

6. Guaranteed by characterization.

Table 13. CSD and IDAC Specifications (continued)

SPEC ID#	Parameter	Description	Min	Typ	Max	Units	Details / Conditions
SID315G	IDAC3CRT23	Output current of IDAC in 8-bit mode in medium range	69	–	82	μA	LSB = 300-nA typ
SID315H	IDAC3CRT33	Output current of IDAC in 8-bit mode in high range	540	–	660	μA	LSB = 2.4-μA typ
SID320	IDACOFFSET	All zeroes input	–	–	1	LSB	Polarity set by Source or Sink. Offset is 2 LSBs for 37.5 nA/LSB mode
SID321	IDACGAIN	Full-scale error less offset	–	–	±10	%	
SID322	IDACMISMATCH1	Mismatch between IDAC1 and IDAC2 in Low mode	–	–	9.2	LSB	LSB = 37.5-nA typ
SID322A	IDACMISMATCH2	Mismatch between IDAC1 and IDAC2 in Medium mode	–	–	5.6	LSB	LSB = 300-nA typ
SID322B	IDACMISMATCH3	Mismatch between IDAC1 and IDAC2 in High mode	–	–	6.8	LSB	LSB = 2.4-μA typ
SID323	IDACSET8	Settling time to 0.5 LSB for 8-bit IDAC	–	–	5	μs	Full-scale transition. No external load
SID324	IDACSET7	Settling time to 0.5 LSB for 7-bit IDAC	–	–	5	μs	Full-scale transition. No external load
SID325	CMOD	External modulator capacitor.	–	2.2	–	nF	5-V rating, X7R or NP0 cap

10-bit CapSense ADC

Table 14. 10-bit CapSense ADC Specifications

Spec ID#	Parameter	Description	Min	Typ	Max	Units	Details/ Conditions
SIDA94	A_RES	Resolution	–	–	10	bits	Auto-zeroing is required every millisecond
SIDA95	A_CHNLS_S	Number of channels - single ended	–	–	16		Defined by AMUX Bus
SIDA97	A-MONO	Monotonicity	–	–	–	Yes	
SIDA98	A_GAINERR	Gain error	–	–	±3	%	In V _{REF} (2.4 V) mode with V _{DDA} bypass capacitance of 10 μF
SIDA99	A_OFFSET	Input offset voltage	–	–	±18	mV	In V _{REF} (2.4 V) mode with V _{DDA} bypass capacitance of 10 μF
SIDA100	A_ISAR	Current consumption	–	–	0.25	mA	
SIDA101	A_VINS	Input voltage range - single ended	V _{SSA}	–	V _{DDA}	V	
SIDA103	A_INRES	Input resistance	–	2.2	–	KΩ	
SIDA104	A_INCAP	Input capacitance	–	20	–	pF	
SIDA106	A_PSR	Power supply rejection ratio	–	60	–	dB	In V _{REF} (2.4 V) mode with V _{DDA} bypass capacitance of 10 μF
SIDA107	A_TACQ	Sample acquisition time	–	1	–	μs	
SIDA108	A_CONV8	Conversion time for 8-bit resolution at conversion rate = F _{hclk} /(2 ^N *(N+2)). Clock frequency = 48 MHz.	–	–	21.3	μs	Does not include acquisition time. Equivalent to 44.8 ksp/s including acquisition time.
SIDA108A	A_CONV10	Conversion time for 10-bit resolution at conversion rate = F _{hclk} /(2 ^N *(N+2)). Clock frequency = 48 MHz.	–	–	85.3	μs	Does not include acquisition time. Equivalent to 11.6 ksp/s including acquisition time.

SPI

Table 18. SPI DC Specifications^[8]

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID163	ISPI1	Block current consumption at 1 Mbps	–	–	360	μA	–
SID164	ISPI2	Block current consumption at 4 Mbps	–	–	560		–
SID165	ISPI3	Block current consumption at 8 Mbps	–	–	600		–

Table 19. SPI AC Specifications^[8]

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID166	FSPI	SPI Operating frequency (Master; 6X Oversampling)	–	–	8	MHz	
Fixed SPI Master Mode AC Specifications							
SID167	TDMO	MOSI Valid after SClock driving edge	–	–	15	ns	–
SID168	TDSI	MISO Valid before SClock capturing edge	20	–	–		Full clock, late MISO sampling
SID169	THMO	Previous MOSI data hold time	0	–	–		Referred to Slave capturing edge
Fixed SPI Slave Mode AC Specifications							
SID170	TDMI	MOSI Valid before Scklock Capturing edge	40	–	–	ns	–
SID171	TDSO	MISO Valid after Scklock driving edge	–	–	42 + 3*Tcpu		T _{CPU} = 1/F _{CPU}
SID171A	TDSO_EXT	MISO Valid after Scklock driving edge in Ext. Clk mode	–	–	48		–
SID172	THSO	Previous MISO data hold time	0	–	–		–
SID172A	TSSELSSCK	SSEL Valid to first SCK Valid edge	–	–	100	ns	–

UART

Table 20. UART DC Specifications^[8]

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID160	I _{UART1}	Block current consumption at 100 Kbps	–	–	55	μA	–
SID161	I _{UART2}	Block current consumption at 1000 Kbps	–	–	312	μA	–

Table 21. UART AC Specifications^[8]

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID162	F _{UART}	Bit rate	–	–	1	Mbps	–

Note

8. Guaranteed by characterization.

Memory

Table 24. Flash DC Specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID173	V _{PE}	Erase and program voltage	1.71	–	5.5	V	–

Table 25. Flash AC Specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID174	T _{ROWWRITE} ^[10]	Row (block) write time (erase and program)	–	–	20	ms	Row (block) = 256 bytes
SID175	T _{ROWERASE} ^[10]	Row erase time	–	–	16		–
SID176	T _{ROWPROGRAM} ^[10]	Row program time after erase	–	–	4		–
SID178	T _{BULKERASE} ^[10]	Bulk erase time (64 KB)	–	–	35		–
SID180 ^[11]	T _{DEVPROG} ^[10]	Total device program time	–	–	7	Seconds	–
SID181 ^[11]	F _{END}	Flash endurance	100 K	–	–	Cycles	–
SID182 ^[11]	F _{RET}	Flash retention. T _A ≤ 55 °C, 100 K P/E cycles	20	–	–	Years	–
SID182A ^[11]	–	Flash retention. T _A ≤ 85 °C, 10 K P/E cycles	10	–	–		–
SID256	TWS48	Number of Wait states at 48 MHz	2	–	–		CPU execution from Flash
SID257	TWS24	Number of Wait states at 24 MHz	1	–	–		CPU execution from Flash

System Resources

Power-on Reset (POR)

Table 26. Power On Reset (PRES)

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID.CLK#6	SR_POWER_UP	Power supply slew rate	1	–	67	V/ms	At power-up
SID185 ^[11]	V _{RISEIPOR}	Rising trip voltage	0.80	–	1.5	V	–
SID186 ^[11]	V _{FALLIPOR}	Falling trip voltage	0.70	–	1.4		–

Table 27. Brown-out Detect (BOD) for V_{CCD}

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID190 ^[11]	V _{FALLPPOR}	BOD trip voltage in active and sleep modes	1.48	–	1.62	V	–
SID192 ^[11]	V _{FALLDPSLP}	BOD trip voltage in Deep Sleep	1.11	–	1.5		–

Notes

10. It can take as much as 20 milliseconds to write to Flash. During this time the device should not be Reset, or Flash operations will be interrupted and cannot be relied on to have completed. Reset sources include the XRES pin, software resets, CPU lockup states and privilege violations, improper power supply levels, and watchdogs. Make certain that these are not inadvertently activated.

11. Guaranteed by characterization.

SWD Interface

Table 28. SWD Interface Specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID213	F_SWDCCLK1	$3.3\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	–	–	14	MHz	SWDCCLK ≤ 1/3 CPU clock frequency
SID214	F_SWDCCLK2	$1.71\text{ V} \leq V_{DD} \leq 3.3\text{ V}$	–	–	7		SWDCCLK ≤ 1/3 CPU clock frequency
SID215 ^[12]	T_SWDI_SETUP	$T = 1/f_{\text{SWDCCLK}}$	$0.25 \cdot T$	–	–	ns	–
SID216 ^[12]	T_SWDI_HOLD	$T = 1/f_{\text{SWDCCLK}}$	$0.25 \cdot T$	–	–		–
SID217 ^[12]	T_SWDO_VALID	$T = 1/f_{\text{SWDCCLK}}$	–	–	$0.5 \cdot T$		–
SID217A ^[12]	T_SWDO_HOLD	$T = 1/f_{\text{SWDCCLK}}$	1	–	–		–

Internal Main Oscillator

Table 29. IMO DC Specifications

(Guaranteed by Design)

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID218	I _{IMO1}	IMO operating current at 48 MHz	–	–	250	μA	–
SID219	I _{IMO2}	IMO operating current at 24 MHz	–	–	180	μA	–

Table 30. IMO AC Specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID223	F _{IMOTOL1}	Frequency variation at 24, 32, and 48 MHz (trimmed)	–	–	±2	%	
SID226	T _{STARTIMO}	IMO startup time	–	–	7	μs	–
SID228	T _{JITRMSIMO2}	RMS jitter at 24 MHz	–	145	–	ps	–

Internal Low-Speed Oscillator

Table 31. ILO DC Specifications

(Guaranteed by Design)

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID231	I _{ILO1}	ILO operating current	–	0.3	1.05	μA	–

Table 32. ILO AC Specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID234 ^[12]	T _{STARTILO1}	ILO startup time	–	–	2	ms	–
SID236 ^[12]	T _{ILODUTY}	ILO duty cycle	40	50	60	%	–
SID237	F _{ILOTRIM1}	ILO frequency range	20	40	80	kHz	–

Note

12. Guaranteed by design.

Smart I/O

Table 38. Smart I/O Pass-through Time (Delay in Bypass Mode)

Spec ID#	Parameter	Description	Min	Typ	Max	Units	Details / Conditions
SID252	PRG_BYPASS	Max delay added by Smart I/O in bypass mode	–	–	1.6	ns	

CAN

Table 39. CAN Specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID420	IDD_CAN	Block current consumption	–	–	200	μA	
SID421	CAN_bits	CAN Bit rate	–	–	1	Mbps	Min 8-MHZ clock

Ordering Information

The marketing part numbers for the PSoC 4100S Plus devices are listed in the following table.

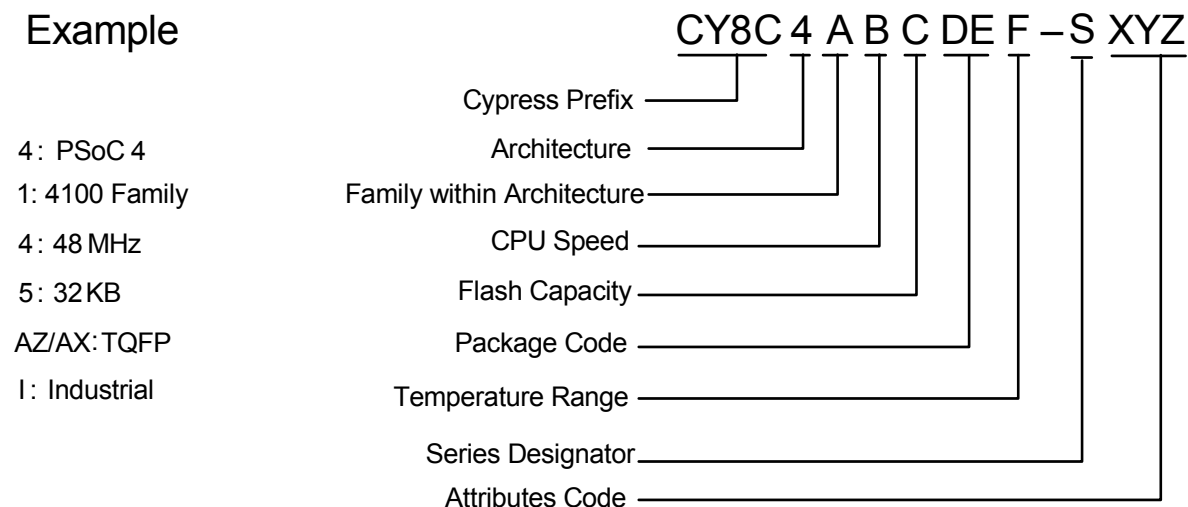
Category	MPN	Features															Packages		
		Max CPU Speed (MHz)	Flash (KB)	SRAM (KB)	Op-amp (CTBm)	CSD	10-bit CSD ADC	12-bit SAR ADC	SAR ADC Sample Rate	LP Comparators	TCPWM Blocks	SCB Blocks	ECO	CAN Controller	Smart I/Os	GPIO	44-TQFP (0.8-mm pitch)	64-TQFP (0.5-mm pitch)	64-TQFP (0.8-mm pitch)
4126	CY8C4126AXI-S443	24	64	8	2	0	1	1	806 ksp/s	2	8	4	✓	0	24	36	✓	–	–
	CY8C4126AZI-S445	24	64	8	2	0	1	1	806 ksp/s	2	8	5	✓	0	24	54	–	✓	–
	CY8C4126AXI-S445	24	64	8	2	0	1	1	806 ksp/s	2	8	5	✓	0	24	54	–	–	✓
	CY8C4126AZI-S455	24	64	8	2	1	1	1	806 ksp/s	2	8	5	✓	0	24	54	–	✓	–
	CY8C4126AXI-S455	24	64	8	2	1	1	1	806 ksp/s	2	8	5	✓	0	24	54	–	–	✓
4146	CY8C4146AXI-S443	48	64	8	2	0	1	1	1 Msps	2	8	4	✓	0	24	36	✓	–	–
	CY8C4146AZI-S445	48	64	8	2	0	1	1	1 Msps	2	8	5	✓	0	24	54	–	✓	–
	CY8C4146AXI-S445	48	64	8	2	0	1	1	1 Msps	2	8	5	✓	0	24	54	–	–	✓
	CY8C4146AXI-S453	48	64	8	2	1	1	1	1 Msps	2	8	4	✓	0	24	36	✓	–	–
	CY8C4146AZI-S455	48	64	8	2	1	1	1	1 Msps	2	8	5	✓	0	24	54	–	✓	–
	CY8C4146AXI-S455	48	64	8	2	1	1	1	1 Msps	2	8	5	✓	0	24	54	–	–	✓
4127	CY8C4127AXI-S443	24	128	16	2	0	1	1	806 ksp/s	2	8	4	✓	0	24	36	✓	–	–
	CY8C4127AZI-S445	24	128	16	2	0	1	1	806 ksp/s	2	8	5	✓	0	24	54	–	✓	–
	CY8C4127AXI-S445	24	128	16	2	0	1	1	806 ksp/s	2	8	5	✓	0	24	54	–	–	✓
	CY8C4127AXI-S453	24	128	16	2	1	1	1	806 ksp/s	2	8	4	✓	0	24	36	✓	–	–
	CY8C4127AZI-S455	24	128	16	2	1	1	1	806 ksp/s	2	8	5	✓	0	24	54	–	✓	–
	CY8C4127AXI-S455	24	128	16	2	1	1	1	806 ksp/s	2	8	5	✓	0	24	54	–	–	✓
4147	CY8C4147AXI-S443	48	128	16	2	0	1	1	1 Msps	2	8	4	✓	0	24	36	✓	–	–
	CY8C4147AZI-S445	48	128	16	2	0	1	1	1 Msps	2	8	5	✓	0	24	54	–	✓	–
	CY8C4147AXI-S445	48	128	16	2	0	1	1	1 Msps	2	8	5	✓	0	24	54	–	–	✓
	CY8C4147AXI-S453	48	128	16	2	1	1	1	1 Msps	2	8	4	✓	0	24	36	✓	–	–
	CY8C4147AZI-S455	48	128	16	2	1	1	1	1 Msps	2	8	5	✓	0	24	54	–	✓	–
	CY8C4147AXI-S455	48	128	16	2	1	1	1	1 Msps	2	8	5	✓	0	24	54	–	–	✓
	CY8C4147AZI-S465	48	128	16	2	0	1	1	1 Msps	2	8	5	✓	1	24	54	–	✓	–
	CY8C4147AXI-S465	48	128	16	2	0	1	1	1 Msps	2	8	5	✓	1	24	54	–	–	✓
	CY8C4147AZI-S475	48	128	16	2	1	1	1	1 Msps	2	8	5	✓	1	24	54	–	✓	–
	CY8C4147AXI-S475	48	128	16	2	1	1	1	1 Msps	2	8	5	✓	1	24	54	–	–	✓

The nomenclature used in the preceding table is based on the following part numbering convention:

Field	Description	Values	Meaning
CY8C	Cypress Prefix		
4	Architecture	4	PSoC 4
A	Family	1	4100 Family
B	CPU Speed	2	24 MHz
		4	48 MHz
C	Flash Capacity	4	16 KB
		5	32 KB
		6	64 KB
		7	128 KB
DE	Package Code	AX	TQFP (0.8-mm pitch)
		AZ	TQFP (0.5-mm pitch)
		LQ	QFN
		PV	SSOP
		FN	CSP
F	Temperature Range	I	Industrial
S	Series Designator	S	PSoC 4 S-Series
		M	PSoC 4 M-Series
		L	PSoC 4 L-Series
		BL	PSoC 4 BLE-Series
XYZ	Attributes Code	000-999	Code of feature set in the specific family

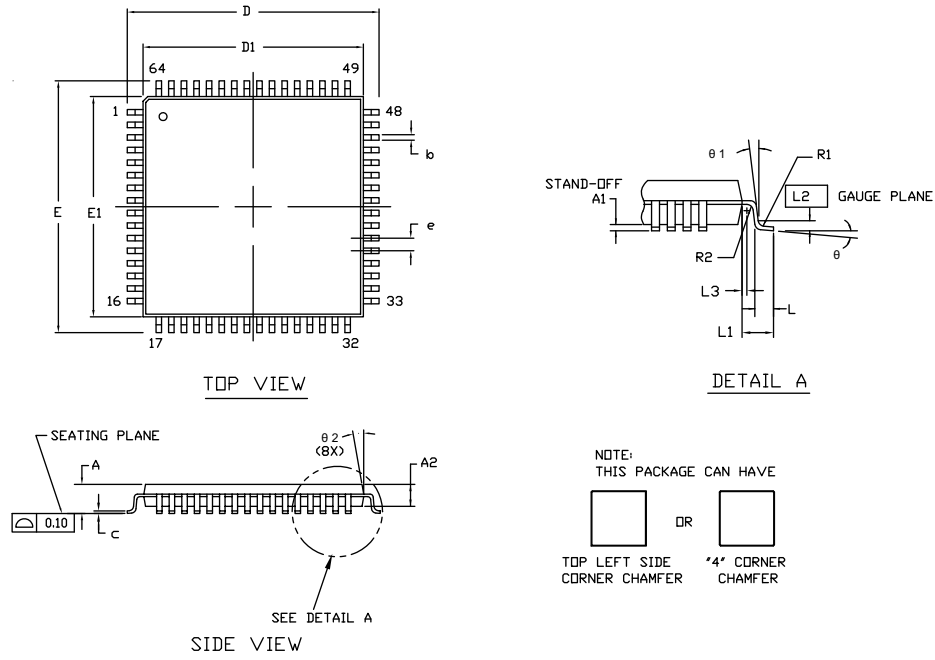
The following is an example of a part number:

Example



Package Diagrams

Figure 7. 64-pin TQFP Package (0.8-mm Pitch) Outline



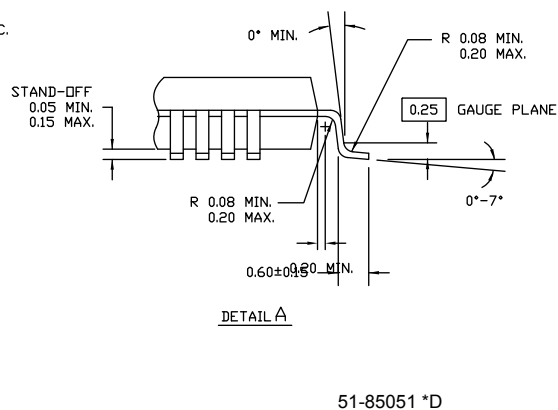
SYMBOL	DIMENSIONS		
	MIN.	NOM.	MAX.
A	—	—	1.60
A1	0.05	—	0.15
A2	1.35	1.40	1.45
D	15.75	16.00	16.25
D1	13.95	14.00	14.05
E	15.75	16.00	16.25
E1	13.95	14.00	14.05
R1	0.08	—	0.20
R2	0.08	—	0.20
θ	0°	—	7°
θ1	0°	—	—
θ2	11°	12°	13°
c	—	—	0.20
b	0.30	0.35	0.40
L	0.45	0.60	0.75
L1	1.00 REF		
L2	0.25 BSC		
L3	0.20	—	—
e	0.80 TYP		

NOTE:

- JEDEC STD REF MS-026
- BODY LENGTH DIMENSION DOES NOT INCLUDE MOLD PROTRUSION/END FLASH
MOLD PROTRUSION/END FLASH SHALL NOT EXCEED 0.0098 in (0.25 mm) PER SIDE
BODY LENGTH DIMENSIONS ARE MAX PLASTIC BODY SIZE INCLUDING MOLD MISMATCH
- DIMENSIONS IN MILLIMETERS

51-85046 *H

DIMENSIONS ARE IN MILLIMETERS



Technical drawing of Detail A, showing a cross-section of a mechanical part. The drawing includes the following dimensions and tolerances:

- STAND-OFF: 0.05 MIN. 0.15 MAX.
- 0° MIN.
- R. 0.08 MIN. 0.20 MAX.
- 0.25
- GAUGE PLANE
- R. 0.08 MIN. 0.20 MIN.
- 0.20 MIN.
- 0-7°
- 0.60±0.15
- 1.00 REF.

DETAIL A

1. JEDEC STD REF MS-026
2. BODY LENGTH DIMENSION DOES NOT INCLUDE MOLD PROTRUSION/END FLASH
MOLD PROTRUSION/END FLASH SHALL NOT EXCEED 0.0098 in (0.25 mm) PER SIDE
BODY LENGTH DIMENSIONS ARE MAX PLASTIC BODY SIZE INCLUDING MOLD MISMATCH
3. DIMENSIONS IN MILLIMETERS

